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### Dimensions

Chip Size	0603
L	1.6mm +/-0.15mm
W	0.8mm +/-0.15mm
T	0.8mm +/-0.10mm
S	0.7mm MIN
B	0.35mm +/-0.15mm

### Packaging Specifications

Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

### General Information

Series	SMD Comm X5R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	6.5 mg
Shelf Life	78 Weeks
MSL	1

### Specifications

Capacitance	2.2 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	16 VDC
Dielectric Withstanding Voltage	40 VDC
Temperature Range	-55/+85°C
Temperature Coefficient	X5R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 0.5Vrms
Dissipation Factor	10% 1kHz 1.0Vrms
Aging Rate	5% Loss/Decade Hour: Referee Time is 48 Hours
Insulation Resistance	45.5 MOhms